



Vincotech

# 10-PZ122PB100SH-M819F28Y

datasheet

flowPHASE 0 + NTC

1200 V / 100 A

## Features

- High efficiency IGBT4 half-bridge
- - High efficiency fast IGBT4 HS half-bridge]
- Full current FWD
- - Full current fast FWD]
- Thermistor

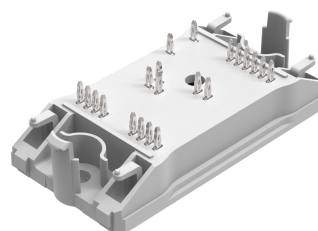
## Target applications

- Industrial Drives
- Power Supply
- Solar Inverters
- UPS
- Welding & Cutting

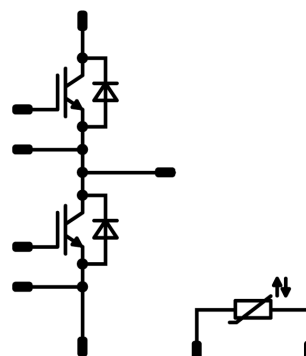
## Types

- 10-PZ122PB100SH-M819F28Y

## flow 0 12 mm housing



## Schematic





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## Maximum Ratings

$T_j = 25\text{ °C}$ , unless otherwise specified

Parameter	Symbol	Conditions	Value	Unit
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### Half-Bridge Switch - Lo side

Collector-emitter voltage	$V_{CES}$		1200	V
Collector current (DC current)	$I_C$	$T_j = T_{jmax}$ $T_s = 80\text{ °C}$	87	A
Repetitive peak collector current	$I_{CRM}$	$t_p$ limited by $T_{jmax}$	300	A
Total power dissipation	$P_{tot}$	$T_j = T_{jmax}$ $T_s = 80\text{ °C}$	201	W
Gate-emitter voltage	$V_{GES}$		$\pm 20$	V
Short circuit ratings	$t_{SC}$	$V_{GE} = 15\text{ V}$ , $V_{CC} = 800\text{ V}$ $T_j = 150\text{ °C}$	10	$\mu s$
Maximum junction temperature	$T_{jmax}$		175	$^{\circ}\text{C}$

### Half-Bridge Diode - Hi side

Peak repetitive reverse voltage	$V_{RRM}$		1200	V
Forward current (DC current)	$I_F$	$T_j = T_{jmax}$ $T_s = 80\text{ °C}$	64	A
Surge (non-repetitive) forward current	$I_{FSM}$	Single Half Sine Wave, $t_p = 10\text{ ms}$ $T_j = 150\text{ °C}$	550	A
Surge current capability	$I^2t$		1513	$A^2s$
Total power dissipation	$P_{tot}$	$T_j = T_{jmax}$ $T_s = 80\text{ °C}$	122	W
Maximum junction temperature	$T_{jmax}$		175	$^{\circ}\text{C}$

### Half-Bridge Switch - Hi side

Collector-emitter voltage	$V_{CES}$		1200	V
Collector current (DC current)	$I_C$	$T_j = T_{jmax}$ $T_s = 80\text{ °C}$	87	A
Repetitive peak collector current	$I_{CRM}$	$t_p$ limited by $T_{jmax}$	300	A
Total power dissipation	$P_{tot}$	$T_j = T_{jmax}$ $T_s = 80\text{ °C}$	201	W
Gate-emitter voltage	$V_{GES}$		$\pm 20$	V
Short circuit ratings	$t_{SC}$	$V_{GE} = 15\text{ V}$ , $V_{CC} = 800\text{ V}$ $T_j = 150\text{ °C}$	10	$\mu s$
Maximum junction temperature	$T_{jmax}$		175	$^{\circ}\text{C}$



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## Maximum Ratings

$T_j = 25\text{ °C}$ , unless otherwise specified

Parameter	Symbol	Conditions	Value	Unit
<b>Half-Bridge Diode - Lo side</b>				
Peak repetitive reverse voltage	$V_{RRM}$		1200	V
Forward current (DC current)	$I_F$	$T_j = T_{jmax}$ $T_s = 80\text{ °C}$	64	A
Surge (non-repetitive) forward current	$I_{FSM}$	Single Half Sine Wave, $t_p = 10\text{ ms}$ $T_j = 150\text{ °C}$	550	A
Surge current capability	$I^2t$		1513	A <sup>2</sup> s
Total power dissipation	$P_{tot}$	$T_j = T_{jmax}$ $T_s = 80\text{ °C}$	122	W
Maximum junction temperature	$T_{jmax}$		175	°C

## Module Properties

### Thermal Properties

Storage temperature	$T_{stg}$		-40...+125	°C
Operation temperature under switching condition	$T_{jop}$		-40...+( $T_{jmax} - 25$ )	°C

### Isolation Properties

Isolation voltage	$V_{isol}$	DC Test Voltage* $t_p = 2\text{ s}$	6000	V
Isolation voltage	$V_{isol}$	AC Voltage $t_p = 1\text{ min}$	2500	V
Creepage distance			>12,7	mm
Clearance			8,08	mm
Comparative Tracking Index	CTI		≥ 200	

\*100 % tested in production



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## Characteristic Values

Parameter	Symbol	Conditions						Values			Unit
			$V_{GE}$ [V] $V_{GS}$ [V]	$V_{CE}$ [V] $V_{DS}$ [V] $V_F$ [V]	$I_C$ [A] $I_D$ [A] $I_F$ [A]	$T_j$ [°C]	Min	Typ	Max		

### Half-Bridge Switch - Lo side

#### Static

Gate-emitter threshold voltage	$V_{GE(th)}$	$V_{CE} = V_{GE}$			0,0038	25	5,1	5,8	6,4	V
Collector-emitter saturation voltage	$V_{CEsat}$		15		100	25 150	1,78	1,95 2,39	2,42 <sup>(1)</sup>	V
Collector-emitter cut-off current	$I_{CES}$		0	1200		25			1,3	µA
Gate-emitter leakage current	$I_{GES}$		20	0		25			120	nA
Internal gate resistance	$r_g$							7,5		Ω
Input capacitance	$C_{ies}$	$f = 1 \text{ Mhz}$	0	25		25		6150		pF
Reverse transfer capacitance	$C_{res}$							345		pF
Gate charge	$Q_g$		15		0	25		800		nC

#### Thermal

Thermal resistance junction to sink <sup>(2)</sup>	$R_{th(j-s)}$	$\lambda_{paste} = 3,4 \text{ W/mK}$ (PSX)						0,47		K/W
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#### Dynamic

Turn-on delay time	$t_{d(on)}$	$R_{gon} = 1 \Omega$ $R_{goff} = 1 \Omega$	$\pm 15$	600	100	25 125 150		129,2 143,2 145,2		ns
Rise time	$t_r$					25 125 150		27,6 30,4 33,8		ns
Turn-off delay time	$t_{d(off)}$					25 125 150		214,2 268,6 282		ns
Fall time	$t_f$					25 125 150		26,36 66,55 76,62		ns
Turn-on energy (per pulse)	$E_{on}$					25 125 150		4,85 7,4 8,5		mWs
Turn-off energy (per pulse)	$E_{off}$					25 125 150		4,12 6,2 6,89		mWs





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## Characteristic Values

Parameter	Symbol	Conditions					Values			Unit
			$V_{GE}$ [V] $V_{GS}$ [V]	$V_{CE}$ [V] $V_{DS}$ [V] $V_F$ [V]	$I_C$ [A] $I_D$ [A] $I_F$ [A]	$T_j$ [°C]	Min	Typ	Max	

### Half-Bridge Diode - Hi side

#### Static

Forward voltage	$V_F$				100	25 125 150		2,3 2,38 2,31	2,52 <sup>(1)</sup> 2,47 <sup>(1)</sup>	V
Reverse leakage current	$I_R$	$V_i = 1200$ V				25 150		8800	120 17700	μA

#### Thermal

Thermal resistance junction to sink <sup>(2)</sup>	$R_{th(j-s)}$	$\lambda_{paste} = 3,4$ W/mK (PSX)						0,78		K/W
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#### Dynamic

Peak recovery current	$I_{RRM}$	$di/dt=3967$ A/μs $di/dt=3671$ A/μs $di/dt=3881$ A/μs	$\pm 15$	600	100	25 125 150		100,94 119,83 129,79		A
Reverse recovery time	$t_{rr}$					25 125 150		157,77 336,7 369,56		ns
Recovered charge	$Q_r$					25 125 150		6,66 13,25 16,16		μC
Reverse recovered energy	$E_{rec}$					25 125 150		2,52 5,3 6,44		mWs
Peak rate of fall of recovery current	$(di_{rr}/dt)_{max}$					25 125 150		4584 3088 2896		A/μs



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## Characteristic Values

Parameter	Symbol	Conditions						Values			Unit
			$V_{GE}$ [V] $V_{GS}$ [V]	$V_{CE}$ [V] $V_{DS}$ [V] $V_F$ [V]	$I_C$ [A] $I_D$ [A] $I_F$ [A]	$T_j$ [°C]	Min	Typ	Max		

### Half-Bridge Switch - Hi side

#### Static

Gate-emitter threshold voltage	$V_{GE(th)}$	$V_{CE} = V_{GE}$			0,0038	25	5,1	5,8	6,4	V
Collector-emitter saturation voltage	$V_{CEsat}$		15		100	25 150	1,78	1,95 2,39	2,42 <sup>(1)</sup>	V
Collector-emitter cut-off current	$I_{CES}$		0	1200		25			1,3	µA
Gate-emitter leakage current	$I_{GES}$		20	0		25			120	nA
Internal gate resistance	$r_g$							7,5		Ω
Input capacitance	$C_{ies}$	$f = 1 \text{ Mhz}$	0	25		25		6150		pF
Reverse transfer capacitance	$C_{res}$							345		pF
Gate charge	$Q_g$		15		0	25		800		nC

#### Thermal

Thermal resistance junction to sink <sup>(2)</sup>	$R_{th(j-s)}$	$\lambda_{paste} = 3,4 \text{ W/mK}$ (PSX)						0,47		K/W
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#### Dynamic

Turn-on delay time	$t_{d(on)}$	$R_{gon} = 1 \Omega$ $R_{goff} = 1 \Omega$	$\pm 15$	600	100	25 125 150		129,2 143,2 145,2		ns
Rise time	$t_r$					25 125 150		27,6 30,4 33,8		ns
Turn-off delay time	$t_{d(off)}$					25 125 150		214,2 268,6 282		ns
Fall time	$t_f$					25 125 150		26,36 66,55 76,62		ns
Turn-on energy (per pulse)	$E_{on}$					25 125 150		4,85 7,4 8,5		mWs
Turn-off energy (per pulse)	$E_{off}$					25 125 150		4,12 6,2 6,89		mWs



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## Characteristic Values

Parameter	Symbol	Conditions						Values			Unit
			$V_{GE}$ [V] $V_{GS}$ [V]	$V_{CE}$ [V] $V_{DS}$ [V] $V_F$ [V]	$I_C$ [A] $I_D$ [A] $I_F$ [A]	$T_j$ [°C]		Min	Typ	Max	

### Half-Bridge Diode - Lo side

#### Static

Forward voltage	$V_F$				100	25 125 150		2,3 2,38 2,31	2,52 <sup>(1)</sup> 2,47 <sup>(1)</sup>	V
Reverse leakage current	$I_R$	$V_i = 1200$ V				25 150		8800	120 17700	µA

#### Thermal

Thermal resistance junction to sink <sup>(2)</sup>	$R_{th(j-s)}$	$\lambda_{paste} = 3,4$ W/mK (PSX)						0,78		K/W
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#### Dynamic

Peak recovery current	$I_{RRM}$	$di/dt=3967$ A/µs $di/dt=3671$ A/µs $di/dt=3881$ A/µs	$\pm 15$	600	100	25 125 150		100,94 119,83 129,79		A
Reverse recovery time	$t_{rr}$					25 125 150		157,77 336,7 369,56		ns
Recovered charge	$Q_r$					25 125 150		6,66 13,25 16,16		µC
Reverse recovered energy	$E_{rec}$					25 125 150		2,52 5,3 6,44		mWs
Peak rate of fall of recovery current	$(di_{rr}/dt)_{max}$					25 125 150		4584 3088 2896		A/µs



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## Characteristic Values

Parameter	Symbol	Conditions					Values			Unit
			$V_{GE}$ [V] $V_{GS}$ [V]	$V_{CE}$ [V] $V_{DS}$ [V] $V_F$ [V]	$I_C$ [A] $I_D$ [A] $I_F$ [A]	$T_j$ [°C]	Min	Typ	Max	

### Thermistor

#### Static

Rated resistance	$R$					25		22		kΩ
Deviation of $R_{100}$	$\Delta_{R/R}$	$R_{100} = 1484 \Omega$				100	-5		5	%
Power dissipation	$P$							5		mW
Power dissipation constant	$d$					25		1,5		mW/K
B-value	$B_{(25/50)}$	Tol. $\pm 1 \%$						3962		K
B-value	$B_{(25/100)}$	Tol. $\pm 1 \%$						4000		K
Vincotech Thermistor Reference									I	

<sup>(1)</sup> Value at chip level

<sup>(2)</sup> Only valid with pre-applied Vincotech thermal interface material.



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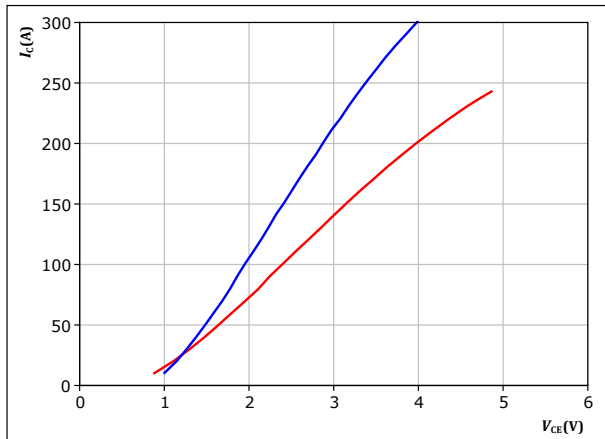
datasheet

## Half-Bridge Switch - Lo side Characteristics

figure 1. IGBT

Typical output characteristics

$$I_C = f(V_{CE})$$

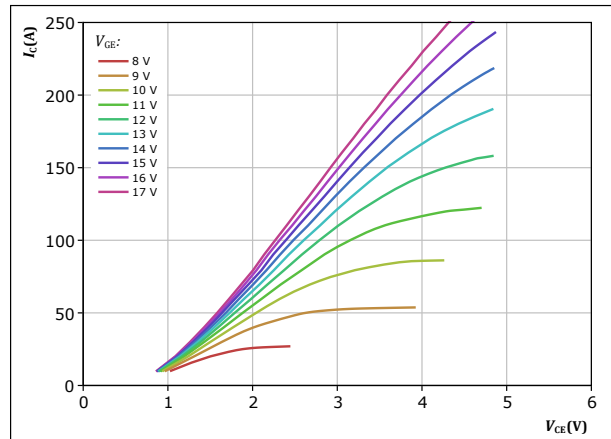


$t_p = 250 \mu s$   
 $V_{GE} = 15 V$   
 $T_J: 25 \text{ } ^\circ C$   
 $150 \text{ } ^\circ C$

figure 2. IGBT

Typical output characteristics

$$I_C = f(V_{CE})$$

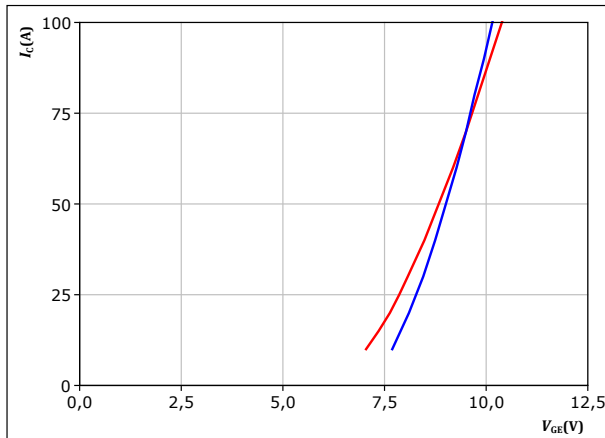


$t_p = 250 \mu s$   
 $T_J = 150 \text{ } ^\circ C$   
 $V_{GE}$  from 8 V to 17 V in steps of 1 V

figure 3. IGBT

Typical transfer characteristics

$$I_C = f(V_{GE})$$

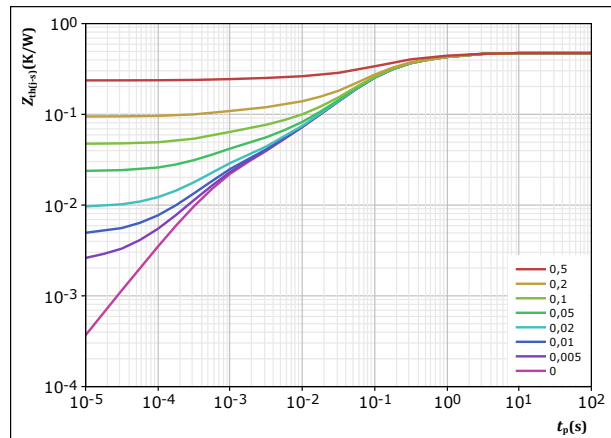


$t_p = 250 \mu s$   
 $V_{CE} = 10 V$   
 $T_J: 25 \text{ } ^\circ C$   
 $150 \text{ } ^\circ C$

figure 4. IGBT

Transient thermal impedance as a function of pulse width

$$Z_{th(j-s)} = f(t_p)$$



$D = t_p / T$   
 $R_{th(j-s)} = 0,473 \text{ K/W}$   
IGBT thermal model values  

$R \text{ (K/W)}$	$\tau \text{ (s)}$
8,95E-02	1,40E+00
1,91E-01	1,86E-01
1,52E-01	5,52E-02
2,19E-02	5,98E-03
1,89E-02	6,39E-04



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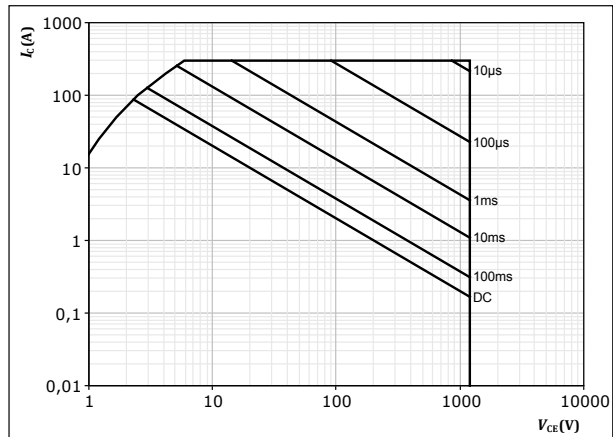
**10-PZ122PB100SH-M819F28Y**  
datasheet

## Half-Bridge Switch - Lo side Characteristics

**figure 5.** IGBT

Safe operating area

$I_C = f(V_{CE})$



$D = \text{single pulse}$

$T_s = 80 \text{ } ^\circ\text{C}$   
 $V_{GE} = 15 \text{ V}$   
 $T_j = T_{jmax}$



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# 10-PZ122PB100SH-M819F28Y

datasheet

## Half-Bridge Diode - Hi side Characteristics

figure 6. FWD

Typical forward characteristics

$$I_F = f(V_F)$$

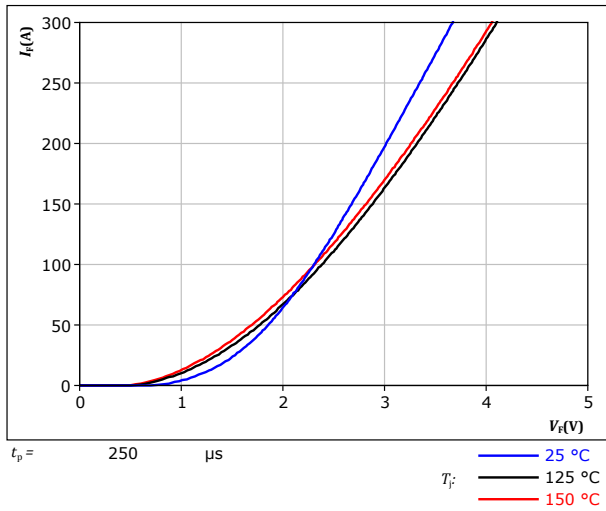
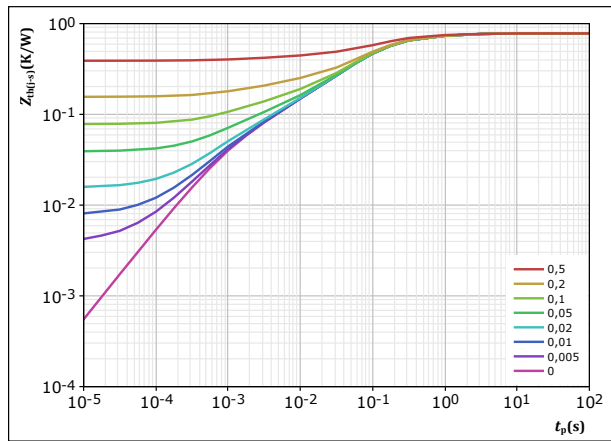


figure 7. FWD

Transient thermal impedance as a function of pulse width

$$Z_{th(j-s)} = f(t_p)$$



$D =$	$t_p / T$
$R_{th(j-s)} =$	0,779 K/W
FWD thermal model values	
$R$ (K/W)	$\tau$ (s)
7,81E-02	1,59E+00
1,93E-01	2,55E-01
3,99E-01	7,68E-02
7,07E-02	6,98E-03
3,88E-02	9,88E-04



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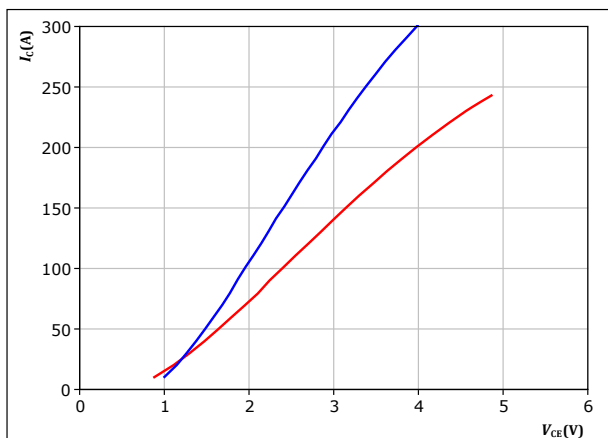
datasheet

## Half-Bridge Switch - Hi side Characteristics

figure 8. IGBT

Typical output characteristics

$$I_C = f(V_{CE})$$

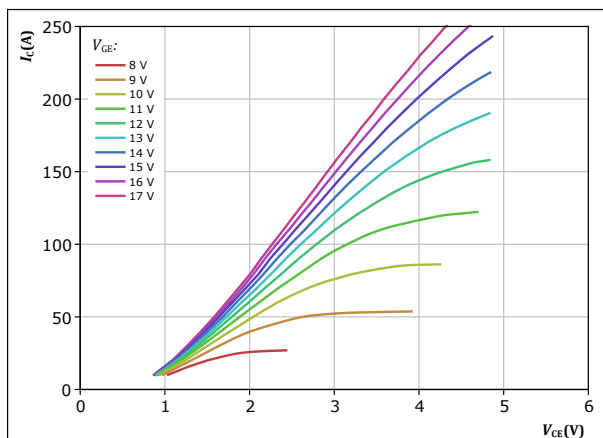


$t_p = 250 \mu s$   
 $V_{GE} = 15 V$   
 $T_j: 25 \text{ } ^\circ C$   
 $150 \text{ } ^\circ C$

figure 9. IGBT

Typical output characteristics

$$I_C = f(V_{CE})$$

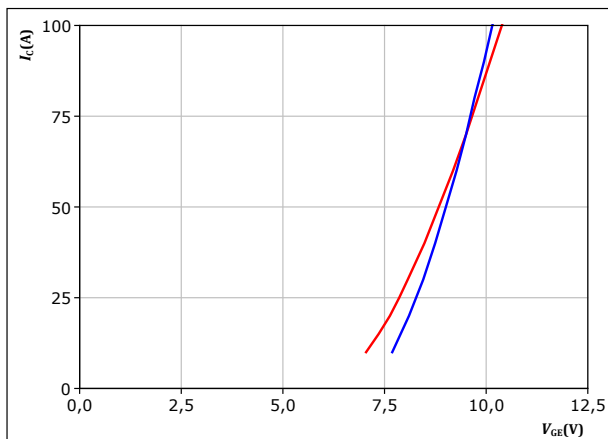


$t_p = 250 \mu s$   
 $T_j = 150 \text{ } ^\circ C$   
 $V_{GE}$  from 8 V to 17 V in steps of 1 V

figure 10. IGBT

Typical transfer characteristics

$$I_C = f(V_{GE})$$

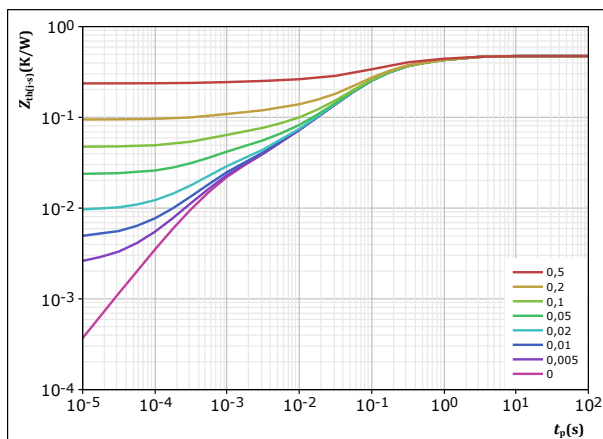


$t_p = 250 \mu s$   
 $V_{CE} = 10 V$   
 $T_j: 25 \text{ } ^\circ C$   
 $150 \text{ } ^\circ C$

figure 11. IGBT

Transient thermal impedance as a function of pulse width

$$Z_{th(j-s)} = f(t_p)$$



$D = t_p / T$   
 $R_{th(j-s)} = 0,473 \text{ K/W}$   
 IGBT thermal model values  

$R \text{ (K/W)}$	$\tau \text{ (s)}$
8,95E-02	1,40E+00
1,91E-01	1,86E-01
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1,89E-02	6,39E-04





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datasheet

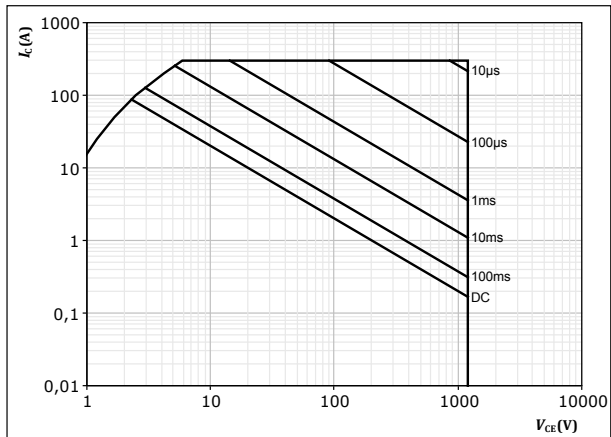
## Half-Bridge Switch - Hi side Characteristics

figure 12.

IGBT

Safe operating area

$$I_C = f(V_{CE})$$



D = single pulse

T<sub>s</sub> = 80 °C

V<sub>GE</sub> = 15 V

T<sub>j</sub> = T<sub>jmax</sub>



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# 10-PZ122PB100SH-M819F28Y

datasheet

## Half-Bridge Diode - Lo side Characteristics

figure 13. FWD

Typical forward characteristics

$$I_F = f(V_F)$$

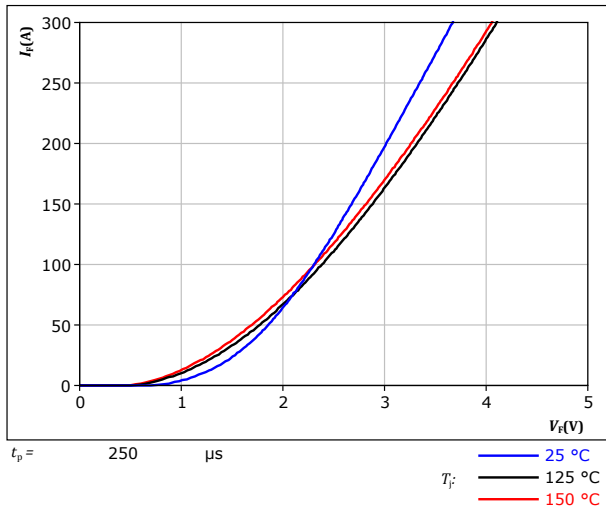
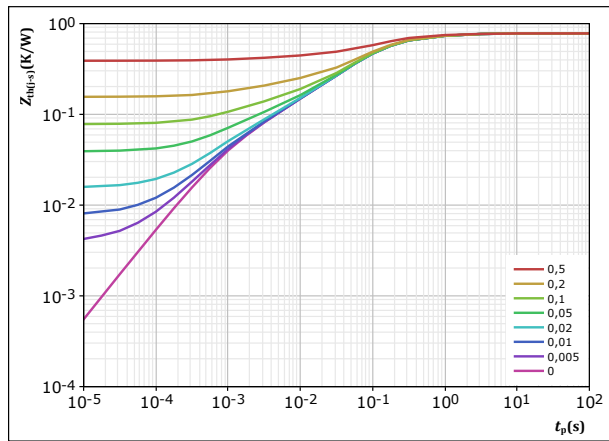


figure 14. FWD

Transient thermal impedance as a function of pulse width

$$Z_{th(j-s)} = f(t_p)$$



$D =$	$t_p / T$
$R_{th(j-s)} =$	0,779 K/W
FWD thermal model values	
$R$ (K/W)	$\tau$ (s)
7,81E-02	1,59E+00
1,93E-01	2,55E-01
3,99E-01	7,68E-02
7,07E-02	6,98E-03
3,88E-02	9,88E-04



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datasheet

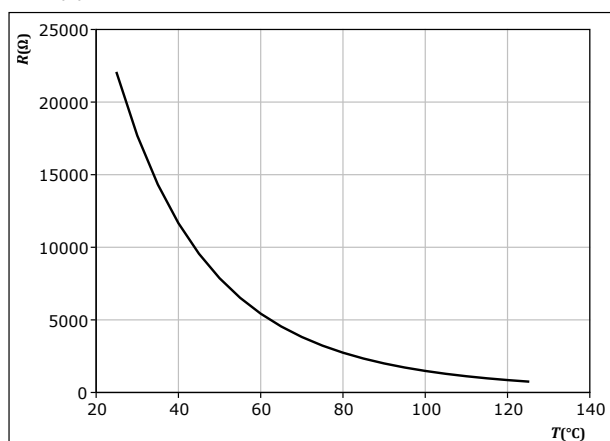
## Thermistor Characteristics

figure 15.

Thermistor

Typical NTC characteristic as function of temperature

$$R_T = f(T)$$





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datasheet

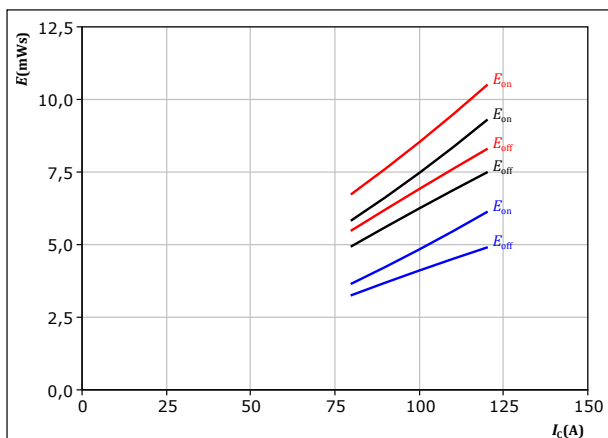
## Half-Bridge Switching Characteristics - Lo side

figure 16.

IGBT

Typical switching energy losses as a function of collector current

$$E = f(I_C)$$



With an inductive load at

$V_{CE} = 600 \text{ V}$   
 $V_{GE} = \pm 15 \text{ V}$   
 $R_{gon} = 1 \text{ } \Omega$   
 $R_{goff} = 1 \text{ } \Omega$

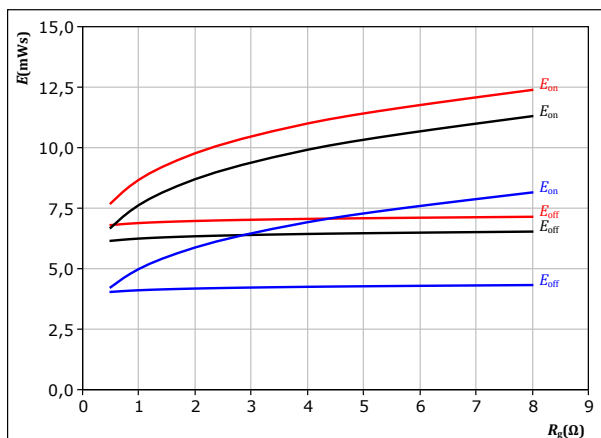
$T_j$ :  
— 25 °C  
— 125 °C  
— 150 °C

figure 17.

IGBT

Typical switching energy losses as a function of gate resistor

$$E = f(R_g)$$



With an inductive load at

$V_{CE} = 600 \text{ V}$   
 $V_{GE} = \pm 15 \text{ V}$   
 $I_C = 100 \text{ A}$

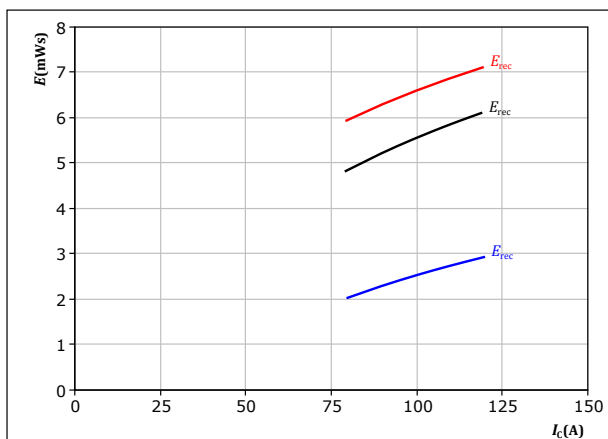
$T_j$ :  
— 25 °C  
— 125 °C  
— 150 °C

figure 18.

FWD

Typical reverse recovered energy loss as a function of collector current

$$E_{rec} = f(I_C)$$



With an inductive load at

$V_{CE} = 600 \text{ V}$   
 $V_{GE} = \pm 15 \text{ V}$   
 $R_{gon} = 1 \text{ } \Omega$

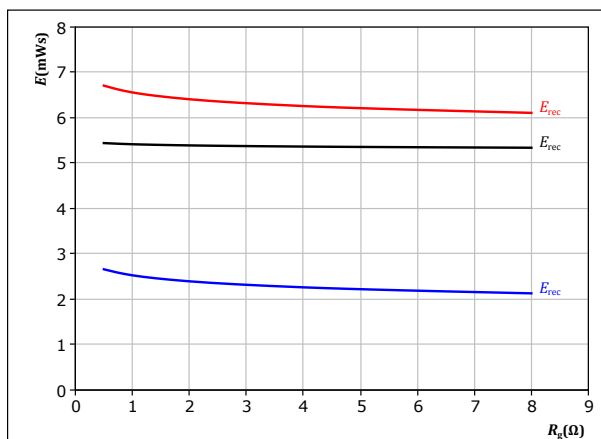
$T_j$ :  
— 25 °C  
— 125 °C  
— 150 °C

figure 19.

FWD

Typical reverse recovered energy loss as a function of gate resistor

$$E_{rec} = f(R_g)$$



With an inductive load at

$V_{CE} = 600 \text{ V}$   
 $V_{GE} = \pm 15 \text{ V}$   
 $I_C = 100 \text{ A}$

$T_j$ :  
— 25 °C  
— 125 °C  
— 150 °C



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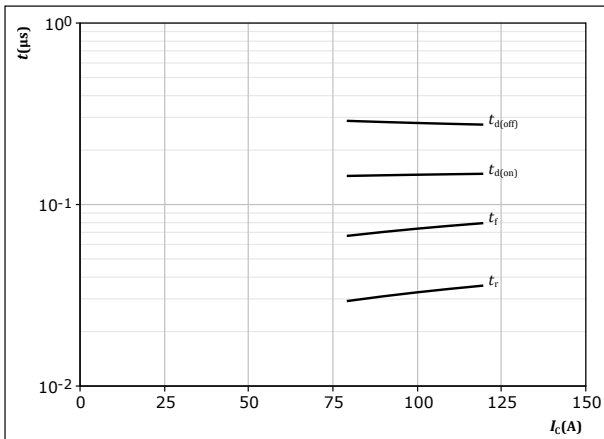
datasheet

## Half-Bridge Switching Characteristics - Lo side

figure 20.

IGBT

Typical switching times as a function of collector current  
 $t = f(I_C)$



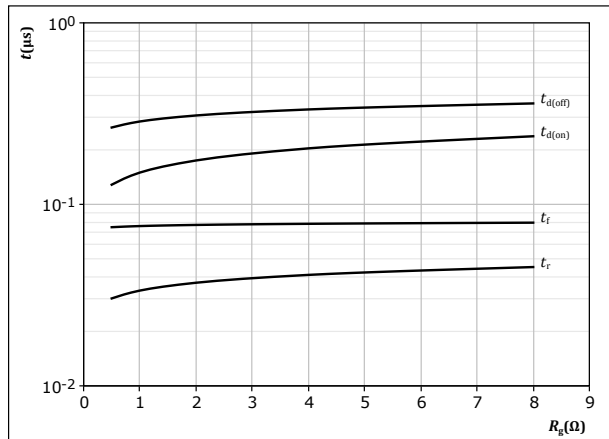
With an inductive load at

$T_j = 150$  °C  
 $V_{CE} = 600$  V  
 $V_{GE} = \pm 15$  V  
 $R_{gon} = 1$  Ω  
 $R_{goff} = 1$  Ω

figure 21.

IGBT

Typical switching times as a function of gate resistor  
 $t = f(R_g)$



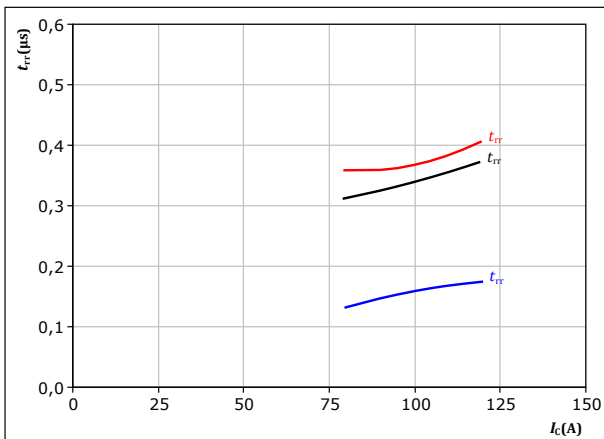
With an inductive load at

$T_j = 150$  °C  
 $V_{CE} = 600$  V  
 $V_{GE} = \pm 15$  V  
 $I_C = 100$  A

figure 22.

FWD

Typical reverse recovery time as a function of collector current  
 $t_{rr} = f(I_C)$



With an inductive load at

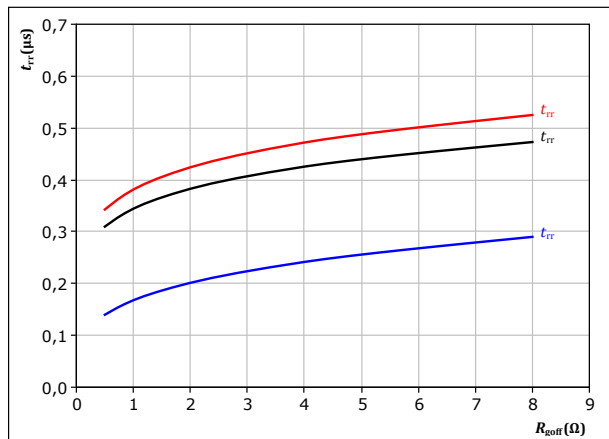
$V_{CE} = 600$  V  
 $V_{GE} = \pm 15$  V  
 $R_{gon} = 1$  Ω

$T_j$ :  
— 25 °C  
— 125 °C  
— 150 °C

figure 23.

FWD

Typical reverse recovery time as a function of IGBT turn off gate resistor  
 $t_{rr} = f(R_{goff})$



With an inductive load at

$V_{CE} = 600$  V  
 $V_{GE} = \pm 15$  V  
 $I_C = 100$  A

$T_j$ :  
— 25 °C  
— 125 °C  
— 150 °C



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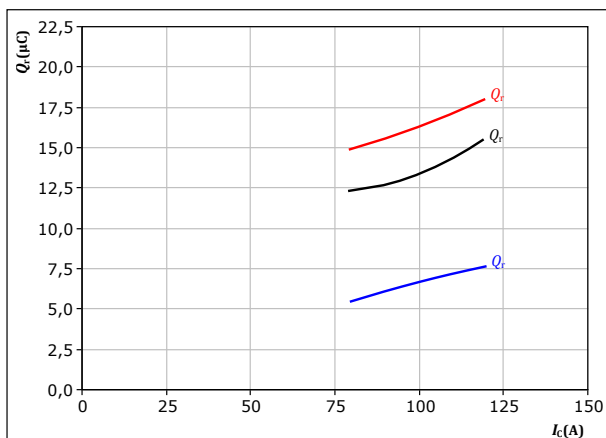
## Half-Bridge Switching Characteristics - Lo side

figure 24.

FWD

Typical recovered charge as a function of collector current

$$Q_r = f(I_c)$$



With an inductive load at

$V_{CE} = 600$  V  
 $V_{GE} = \pm 15$  V  
 $R_{gon} = 1$  Ω

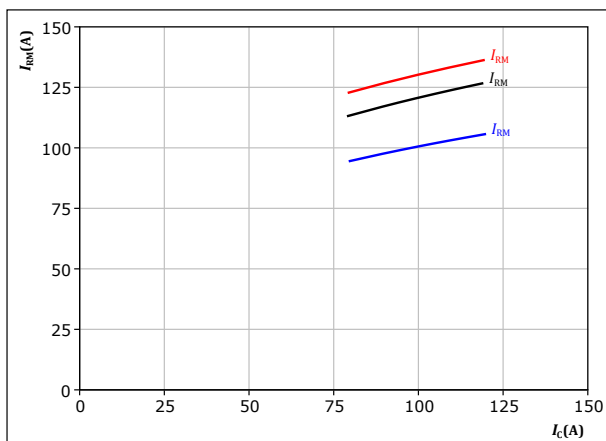
$T_j$ :  
— 25 °C  
— 125 °C  
— 150 °C

figure 26.

FWD

Typical peak reverse recovery current as a function of collector current

$$I_{RM} = f(I_c)$$



With an inductive load at

$V_{CE} = 600$  V  
 $V_{GE} = \pm 15$  V  
 $R_{gon} = 1$  Ω

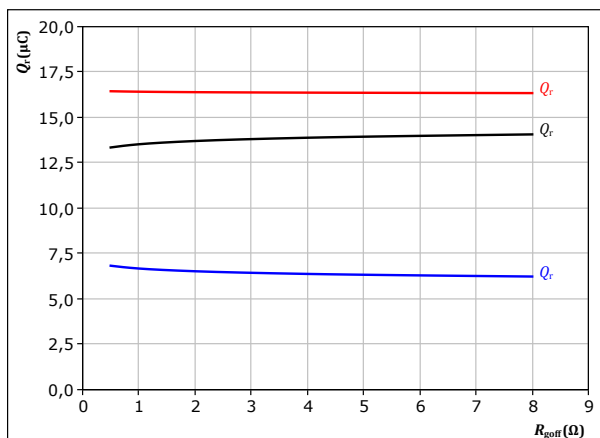
$T_j$ :  
— 25 °C  
— 125 °C  
— 150 °C

figure 25.

FWD

Typical recovered charge as a function of turn off gate resistor

$$Q_r = f(R_{goff})$$



With an inductive load at

$V_{CE} = 600$  V  
 $V_{GE} = \pm 15$  V  
 $I_c = 100$  A

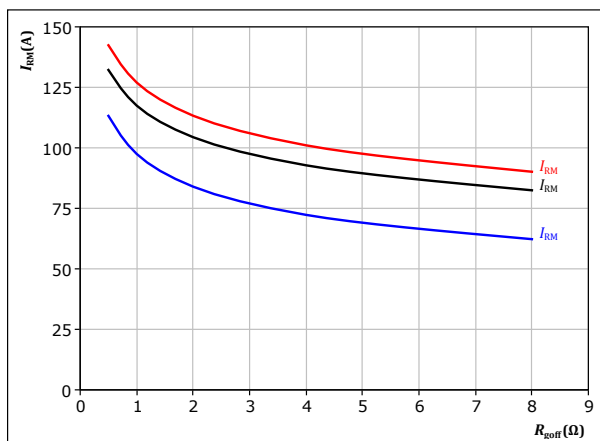
$T_j$ :  
— 25 °C  
— 125 °C  
— 150 °C

figure 27.

FWD

Typical peak reverse recovery current as a function of turn off gate resistor

$$I_{RM} = f(R_{goff})$$



With an inductive load at

$V_{CE} = 600$  V  
 $V_{GE} = \pm 15$  V  
 $I_c = 100$  A

$T_j$ :  
— 25 °C  
— 125 °C  
— 150 °C



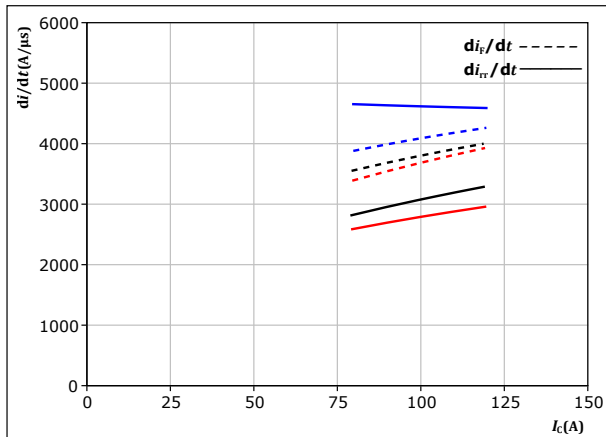
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datasheet

## Half-Bridge Switching Characteristics - Lo side

figure 28. FWD

Typical rate of fall of forward and reverse recovery current as a function of collector current  
 $di_f/dt, di_r/dt = f(I_C)$



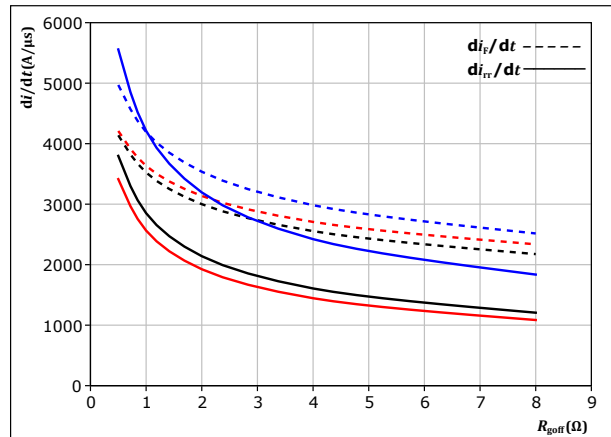
With an inductive load at

$V_{CE} = 600$  V  
 $V_{GE} = \pm 15$  V  
 $R_{goff} = 1$  Ω

$T_j$ : 25 °C (blue), 125 °C (black), 150 °C (red)

figure 29. FWD

Typical rate of fall of forward and reverse recovery current as a function of turn off gate resistor  
 $di_f/dt, di_r/dt = f(R_{goff})$



With an inductive load at

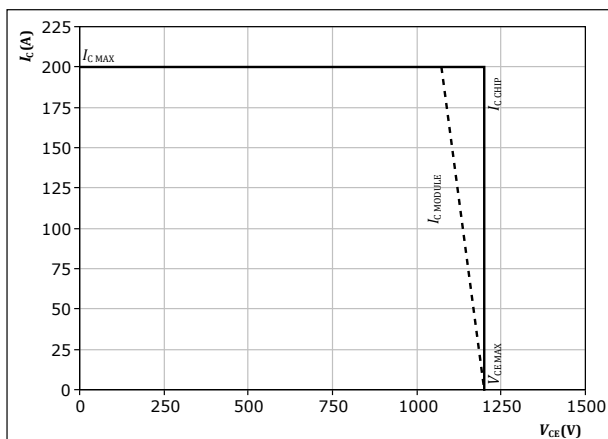
$V_{CE} = 600$  V  
 $V_{GE} = \pm 15$  V  
 $I_C = 100$  A

$T_j$ : 25 °C (blue), 125 °C (black), 150 °C (red)

figure 30. IGBT

Reverse bias safe operating area

$I_C = f(V_{CE})$



At  $T_j = 150$  °C  
 $R_{goff} = 1$  Ω  
 $R_{goff} = 1$  Ω



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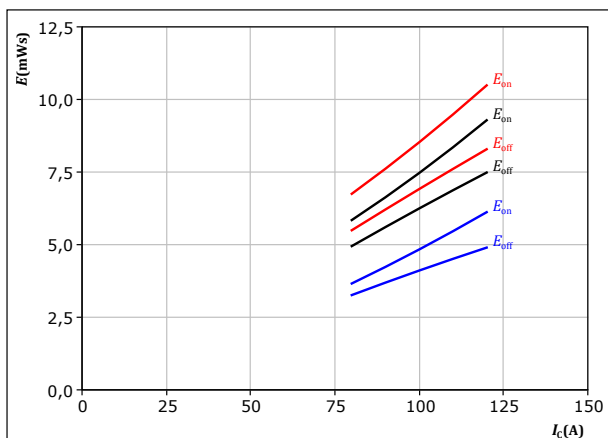
## Half-Bridge Switching Characteristics - Hi side

figure 31.

IGBT

Typical switching energy losses as a function of collector current

$$E = f(I_C)$$



With an inductive load at

$V_{CE} = 600 \text{ V}$   
 $V_{GE} = \pm 15 \text{ V}$   
 $R_{gon} = 1 \text{ } \Omega$   
 $R_{goff} = 1 \text{ } \Omega$

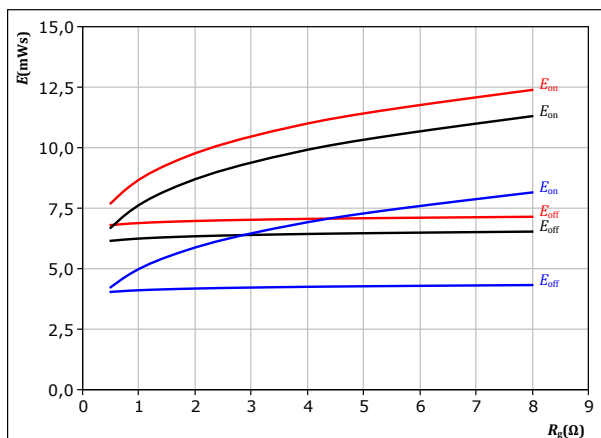
$T_j$ : 25 °C  
125 °C  
150 °C

figure 32.

IGBT

Typical switching energy losses as a function of gate resistor

$$E = f(R_g)$$



With an inductive load at

$V_{CE} = 600 \text{ V}$   
 $V_{GE} = \pm 15 \text{ V}$   
 $I_C = 100 \text{ A}$

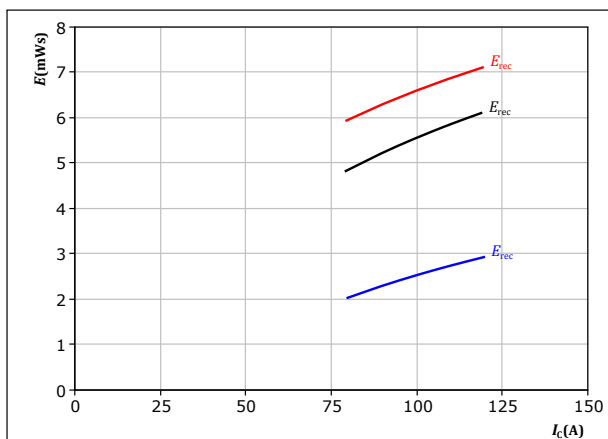
$T_j$ : 25 °C  
125 °C  
150 °C

figure 33.

FWD

Typical reverse recovered energy loss as a function of collector current

$$E_{rec} = f(I_C)$$



With an inductive load at

$V_{CE} = 600 \text{ V}$   
 $V_{GE} = \pm 15 \text{ V}$   
 $R_{gon} = 1 \text{ } \Omega$

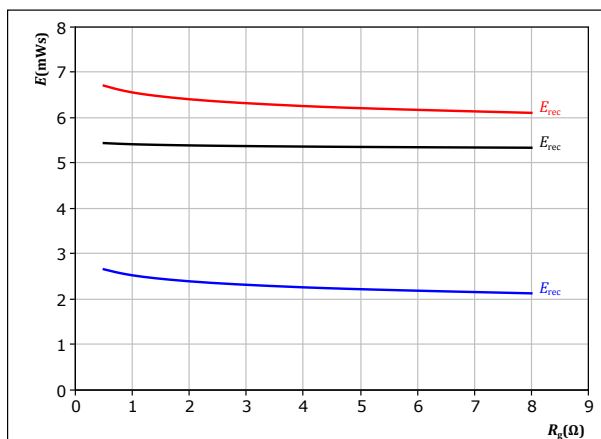
$T_j$ : 25 °C  
125 °C  
150 °C

figure 34.

FWD

Typical reverse recovered energy loss as a function of gate resistor

$$E_{rec} = f(R_g)$$



With an inductive load at

$V_{CE} = 600 \text{ V}$   
 $V_{GE} = \pm 15 \text{ V}$   
 $I_C = 100 \text{ A}$

$T_j$ : 25 °C  
125 °C  
150 °C





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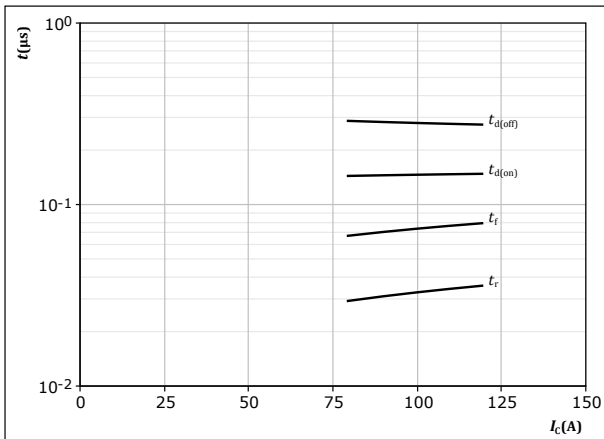
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## Half-Bridge Switching Characteristics - Hi side

figure 35.

IGBT

Typical switching times as a function of collector current  
 $t = f(I_C)$



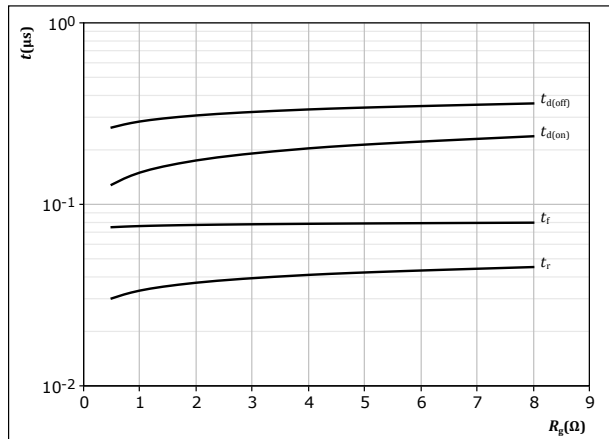
With an inductive load at

$T_j = 150 \text{ } ^\circ\text{C}$   
 $V_{CE} = 600 \text{ V}$   
 $V_{GE} = \pm 15 \text{ V}$   
 $R_{gon} = 1 \text{ } \Omega$   
 $R_{goff} = 1 \text{ } \Omega$

figure 36.

IGBT

Typical switching times as a function of gate resistor  
 $t = f(R_g)$



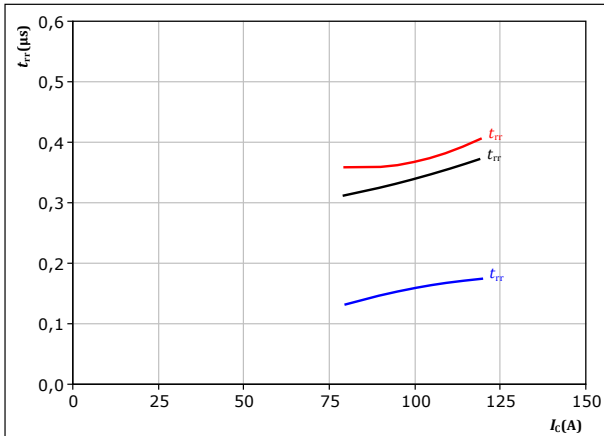
With an inductive load at

$T_j = 150 \text{ } ^\circ\text{C}$   
 $V_{CE} = 600 \text{ V}$   
 $V_{GE} = \pm 15 \text{ V}$   
 $I_C = 100 \text{ A}$

figure 37.

FWD

Typical reverse recovery time as a function of collector current  
 $t_{rr} = f(I_C)$



With an inductive load at

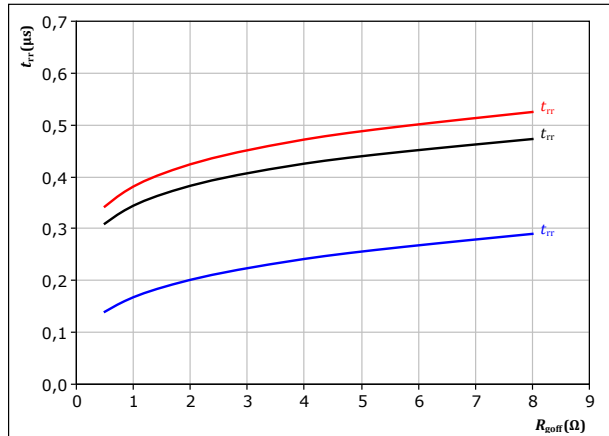
$V_{CE} = 600 \text{ V}$   
 $V_{GE} = \pm 15 \text{ V}$   
 $R_{gon} = 1 \text{ } \Omega$

$T_j$ : — 25 °C  
— 125 °C  
— 150 °C

figure 38.

FWD

Typical reverse recovery time as a function of IGBT turn off gate resistor  
 $t_{rr} = f(R_{goff})$



With an inductive load at

$V_{CE} = 600 \text{ V}$   
 $V_{GE} = \pm 15 \text{ V}$   
 $I_C = 100 \text{ A}$

$T_j$ : — 25 °C  
— 125 °C  
— 150 °C



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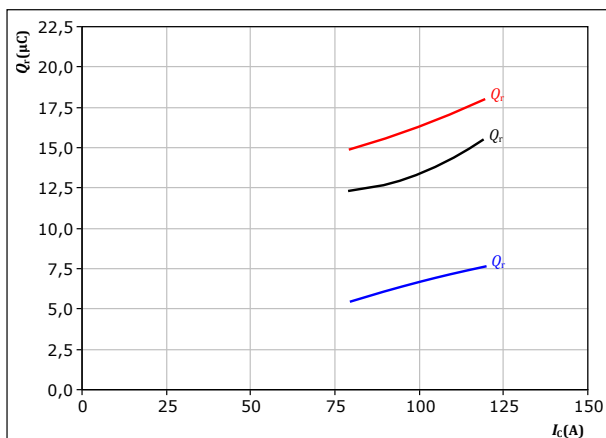
## Half-Bridge Switching Characteristics - Hi side

figure 39.

FWD

Typical recovered charge as a function of collector current

$$Q_r = f(I_c)$$



With an inductive load at

$V_{CE} = 600$  V  
 $V_{GE} = \pm 15$  V  
 $R_{gon} = 1$  Ω

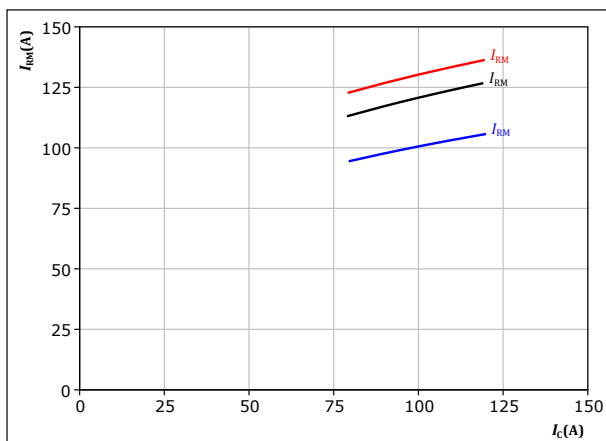
$T_j$ :  
— 25 °C  
— 125 °C  
— 150 °C

figure 41.

FWD

Typical peak reverse recovery current as a function of collector current

$$I_{RM} = f(I_c)$$



With an inductive load at

$V_{CE} = 600$  V  
 $V_{GE} = \pm 15$  V  
 $R_{gon} = 1$  Ω

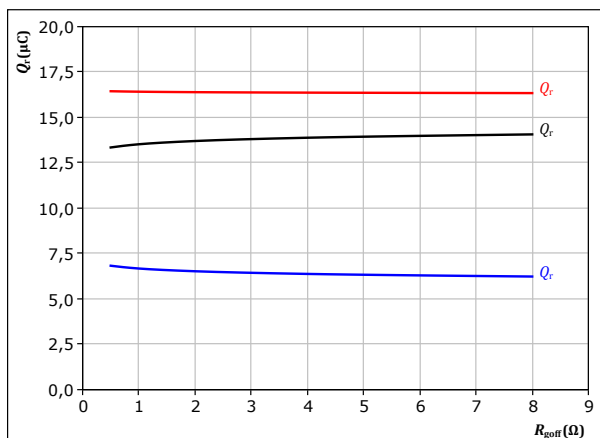
$T_j$ :  
— 25 °C  
— 125 °C  
— 150 °C

figure 40.

FWD

Typical recovered charge as a function of turn off gate resistor

$$Q_r = f(R_{goff})$$



With an inductive load at

$V_{CE} = 600$  V  
 $V_{GE} = \pm 15$  V  
 $I_c = 100$  A

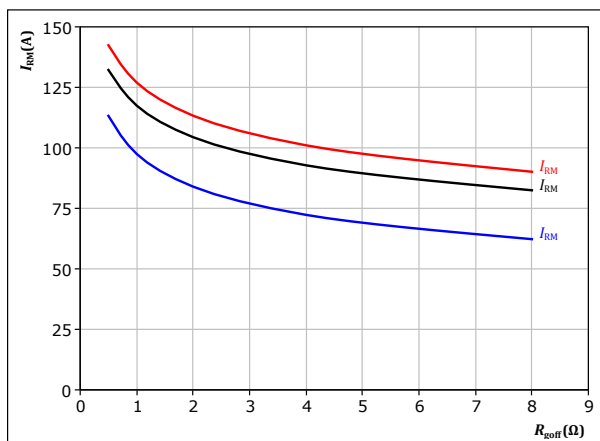
$T_j$ :  
— 25 °C  
— 125 °C  
— 150 °C

figure 42.

FWD

Typical peak reverse recovery current as a function of turn off gate resistor

$$I_{RM} = f(R_{goff})$$



With an inductive load at

$V_{CE} = 600$  V  
 $V_{GE} = \pm 15$  V  
 $I_c = 100$  A

$T_j$ :  
— 25 °C  
— 125 °C  
— 150 °C



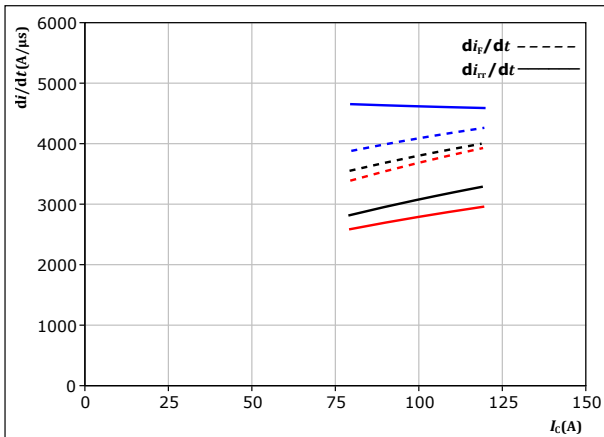
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## Half-Bridge Switching Characteristics - Hi side

figure 43. FWD

Typical rate of fall of forward and reverse recovery current as a function of collector current  
 $di_f/dt, di_r/dt = f(I_C)$



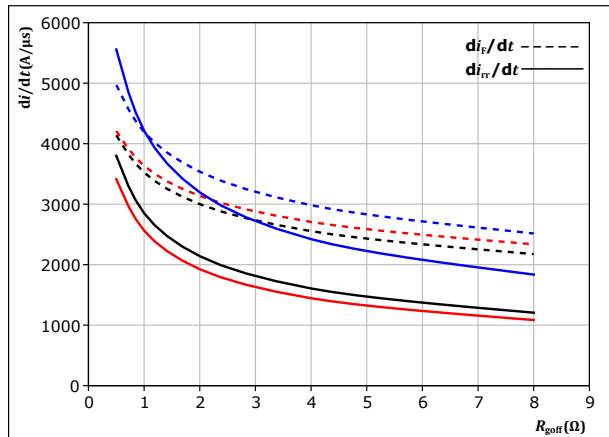
With an inductive load at

$V_{CE} = 600 \text{ V}$   
 $V_{GE} = \pm 15 \text{ V}$   
 $R_{goff} = 1 \Omega$

$T_j:$  — 25 °C  
— 125 °C  
— 150 °C

figure 44. FWD

Typical rate of fall of forward and reverse recovery current as a function of turn off gate resistor  
 $di_f/dt, di_r/dt = f(R_{goff})$



With an inductive load at

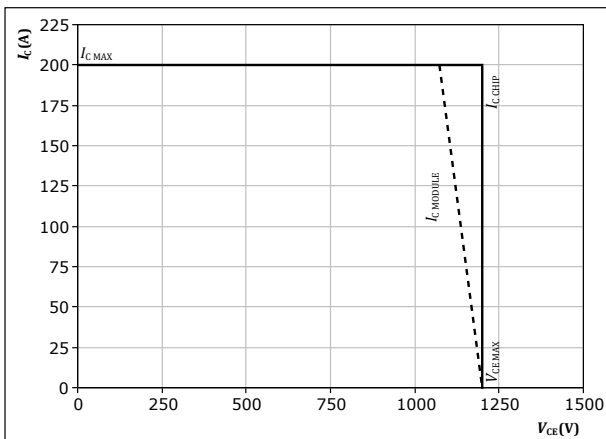
$V_{CE} = 600 \text{ V}$   
 $V_{GE} = \pm 15 \text{ V}$   
 $I_C = 100 \text{ A}$

$T_j:$  — 25 °C  
— 125 °C  
— 150 °C

figure 45. IGBT

Reverse bias safe operating area

$I_C = f(V_{CE})$



At  $T_j = 150 \text{ °C}$   
 $R_{goff} = 1 \Omega$   
 $R_{goff} = 1 \Omega$



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datasheet

## Switching Definitions

figure 46. IGBT

Turn-off Switching Waveforms & definition of  $t_{doff}$ ,  $t_{Eoff}$  ( $t_{Eoff}$  = integrating time for  $E_{off}$ )

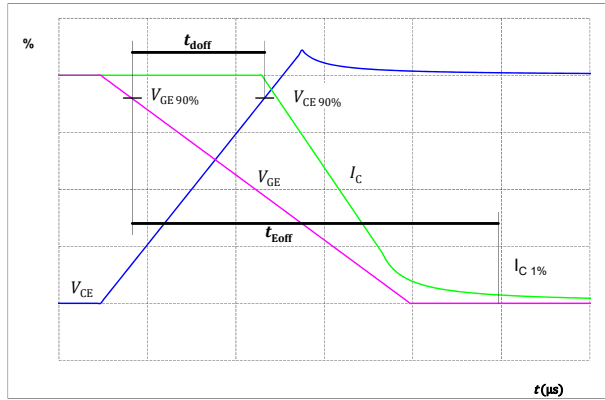


figure 47. IGBT

Turn-on Switching Waveforms & definition of  $t_{don}$ ,  $t_{Eon}$  ( $t_{Eon}$  = integrating time for  $E_{on}$ )

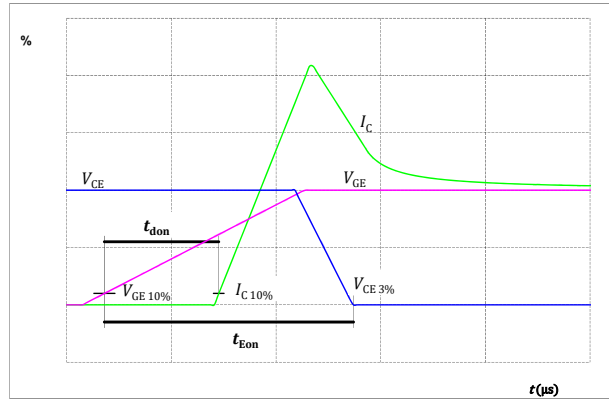


figure 48. IGBT

Turn-off Switching Waveforms & definition of  $t_f$

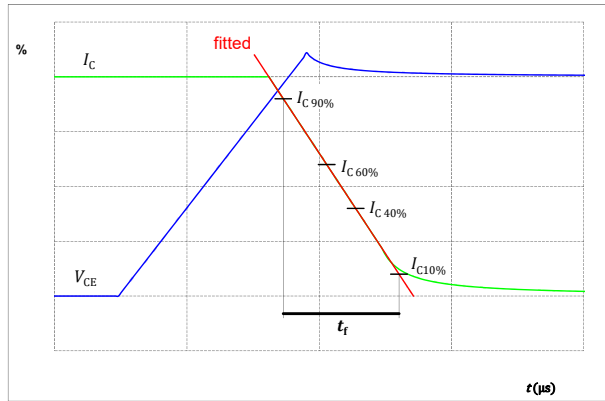
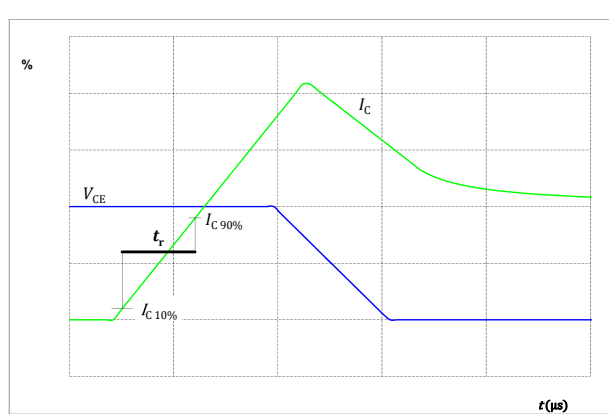


figure 49. IGBT

Turn-on Switching Waveforms & definition of  $t_r$





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## Switching Definitions

figure 50.

FWD

Turn-off Switching Waveforms & definition of  $t_{rr}$

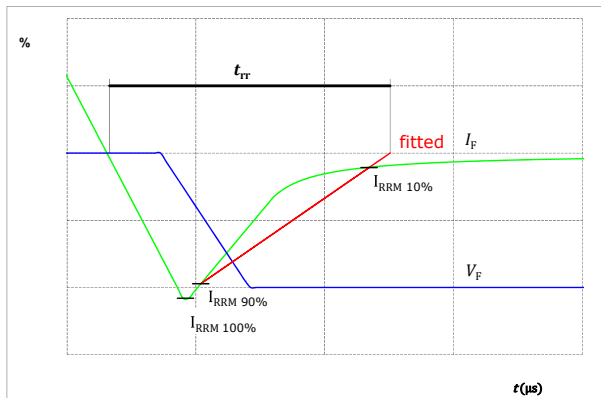
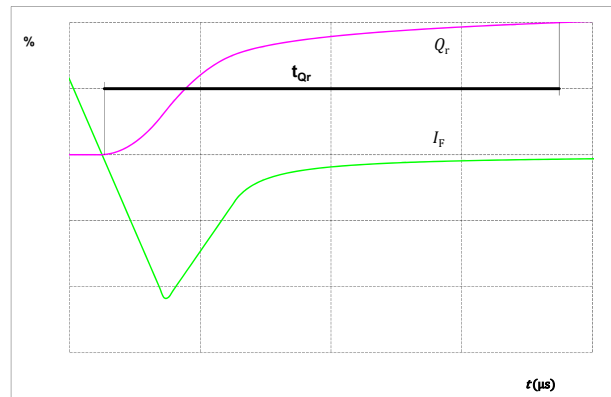


figure 51.

FWD


Turn-on Switching Waveforms & definition of  $t_{Qr}$  ( $t_{Qr}$  = integrating time for  $Q_r$ )





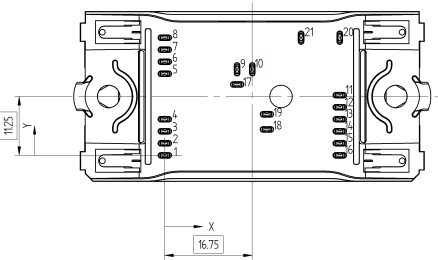
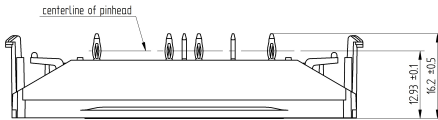
datasheet

Ordering Code	
Version	Ordering Code
Without thermal paste	10-PZ122PB100SH-M819F28Y
With thermal paste (5,2 W/mK, PTM6000HV)	10-PZ122PB100SH-M819F28Y-/7/
With thermal paste (3,4 W/mK, PSX-P7)	10-PZ122PB100SH-M819F28Y-/3/

Marking							
	Text	Name		Date code	UL & VIN	Lot	Serial
		NN-NNNNNNNNNNNNNN- TTTTTIVV		WWYY	UL VIN	LLLL	SSSS
	Datamatrix	Type&Ver	Lot number	Serial	Date code		
	TTTTTIVV	LLLL	SSSS	WWYY			

### Outline

Pin table [mm]			
Pin	X	Y	Function
1	0	0	DC-
2	0	2,3	DC-
3	0	4,6	DC-
4	0	6,9	DC-
5	0	15,6	DC+
6	0	17,9	DC+
7	0	20,2	DC+
8	0	22,5	DC+
9	13,85	16,45	G12
10	16,75	16,45	S12
11	33,5	11,5	Ph
12	33,5	9,2	Ph
13	33,5	6,9	Ph
14	33,5	4,6	Ph
15	33,5	2,3	Ph
16	33,5	0	Ph
17	13,85	13,55	Ph
18	19,55	4,95	S11
19	19,55	7,85	G11
20	33,5	22,5	Therm1
21	26,1	22,5	Therm2

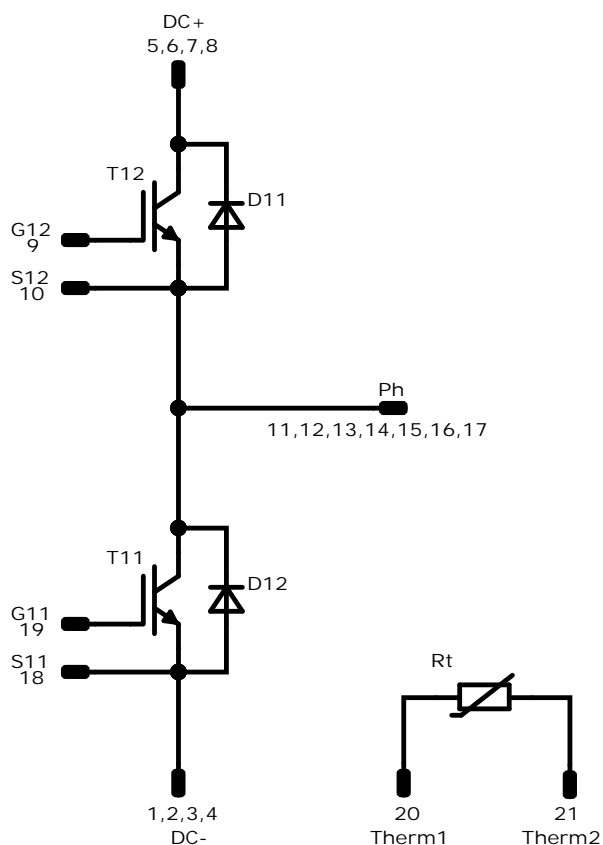
Tolerance of pinpositions: ±0,5mm at the end of pins  
Dimension of coordinate axis is only offset without tolerance



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**10-PZ122PB100SH-M819F28Y**  
datasheet

Pinout



Identification

ID	Component	Voltage	Current	Function	Comment
T11-a	IGBT	1200 V	100 A	Half-Bridge Switch - Lo side	
D11-a	FWD	1200 V	100 A	Half-Bridge Diode - Hi side	
T12-a	IGBT	1200 V	100 A	Half-Bridge Switch - Hi side	
D12-a	FWD	1200 V	100 A	Half-Bridge Diode - Lo side	
Rt	NTC			Thermistor	



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**10-PZ122PB100SH-M819F28Y**  
datasheet

Packaging instruction				
Standard packaging quantity (SPQ) 135	>SPQ	Standard	<SPQ	Sample

Handling instruction
Handling instructions for <i>flow 0</i> packages see vincotech.com website.

Package data
Package data for <i>flow 0</i> packages see vincotech.com website.

Vincotech thermistor reference
See Vincotech thermistor reference table at vincotech.com website.

UL recognition and file number
This device is certified according to UL 1557 standard, UL file number E192116. For more information see vincotech.com website.



Document No.:	Date:	Modification:	Pages
10-PZ122PB100SH-M819F28Y-D3-14	27 Sep. 2021	Diode static characteristics corrected Updated clearance value New datasheet format, module is unchanged	

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2. A critical component is any component of a life support device or system whose failure to perform can be reasonably expected to cause the failure of the life support device or system, or to affect its safety or effectiveness.